

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
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	TOHRU KAWAMOTO	11/21/2016
	PARAJULI DURGA	11/15/2016
	HISASHI TANAKA	11/24/2016
	YUTAKA SUGIYAMA	11/22/2016
	YUKIYA HAKUTA	11/22/2016
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	Property Type	Number
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DATE SIGNED:	12/02/2016	

Total Attachments: 2

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ASSIGNMENT

For value received, we, 1)Akira TAKAHASHI; 2)Tohru KAWAMOTO;
3)Parajuli DURGA; 4) Hisashi TANAKA; 5) Yutaka SUGIYAMA; and 6)Yukiya
HAKUTA having post office address at c/o National Institute of
Advanced Industrial Science and Technology Tsukuba Central 5, 1-1,
Higashi 1-chome, Tsukuba-shi, IBARAKI 305-8565 JAPAN, respectively
hereby sell, assign and transfer to NATIONAL INSTITUTE OF ADVANCED
INDUSTRIAL SCIENCE AND TECHNOLOGY a corporation existing under the
laws of Japan Located at 3-1, Kasumigaseki 1-chome, Chiyoda-ku,
TOKYO 100-8921 JAPAN and its successors, assigns, and legal
representatives the entire right, title, and interest for all
countries including the United States of America, in and to certain
inventions relating to

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described in application for Letters Patent of the United States,
executed by me/us on this date, and all patents which may be granted
therefor, and all divisions, reissues, continuations and extensions
thereof, and authorize and request the Commissioner of Patents and
Trademarks to issue all patents on said improvements or resulting
therefrom to said Company as assignee of the entire interest, and
covenant that I/We have full right so to do, and agree that I/We
will communicate to said Company or its representatives any facts
known to me/us respecting said improvements and testify in any legal
proceedings, sign all lawful papers, execute all divisional,
continuing and reissue applications, make all rightful oaths and
generally do everything possible to aid said Company, its successors,
assigns, and nominees, to obtain and enforce proper protection for
said invention in the United States.

Signature Akira Takahashi Date 2016.11.21
Akira TAKAHASHI

Signature Tohru Kawamoto Date 2016.11.21
Tohru KAWAMOTO

Signature Durga Parajuli Date 2016.11.15
Parajuli DURGA

Signature Hisashi Tanaka Date 2016.11.24
Hisashi TANAKA

Signature Yutaka Sugiyama Date 2016.11.22
Yutaka SUGIYAMA

Signature Yukiya Hakuta Date 2016.11.22
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